



EIPC SPEeDNEWS

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NEWS FROM THE UK

IMAPS UK Packaging Workshop Details Announced

We are pleased to announce our forthcoming Packaging Workshop taking place on 3 July 2014 at Microsemi, Caldicot NP26 5YW.

This unique workshop, organised by IMAPS-UK and sponsored by Microsemi is your opportunity to learn about the technology of Semiconductor device Packaging and discover how to select the right solutions for your existing, new and emerging applications.

Featuring a series of technical presentations, user/supplier case studies, clean-room tours and extensive networking time, the Workshop will review the key issues of packaging and will include:

- Basics of Packaging
- Hermeticity
- Plastic Packaging Trends
- User Case Studies
- Supplier Case Studies

There are limited places available and we expect the spaces to fill up quickly; just three days after our initial announcement, the event is already over 25% full!

Please visit our website for more details: <http://www.imaps.org.uk>
or:



To register for this event: <https://www.regonline.co.uk/pw14>

Thank you,
Andy Longford, IMAPS-UK Secretariat
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Teknoflex Interconnect Solutions passed AS9100C audit

Teknoflex Interconnect Solutions Ltd is in fine form after the results of their first surveillance audit of the AS9100C program.

The company passed with zero non-conformities and their AS9100C certification continues. David Knight, director of quality and process engineering at TISL, said: "We were pleased with the recent result in our AS9100C audit. For a company that is just over a year old to complete its first surveillance audit without the need to raise a single non conformance is testament to the commitment of the staff at TISL to the integrity of the AS9100C Scheme."

He continued, "This result, coming on the back of our ISO14001 Environmental audit earlier in the month, which we also completed without any Non Conformances, shows the level of commitment TISL staff affords to our quality systems."

